



Product data sheet

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Features

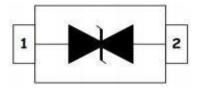
- Ultra low leakage: nA level
- Operating voltage: 5V
- Low clamping voltage
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test Air discharge: ±15kV
 - Contact discharge: ±8kV
 - IEC61000-4-4 (EFT) 40A (5/50ns)
 - IEC61000-4-5 (Lightning) 15A (8/20 μs)
- RoHS Compliant



SOD-323



Pin Configuration



Applications

- USB 2.0 power and data line
- Set-top box and digital TV
- Digital video interface (DVI)
- Notebook Computers
- SIM Ports
- 10/100 Ethernet

Mechanical Characteristics

- Package: SOD-323
- Lead Finish: Lead Free
- UL Flammability Classification Rating 94V-0
- Quantity Per Reel:3,000pcs
- Reel Size:7 inch

Electrical Characteristics (TA=25°C unless otherwise specified)

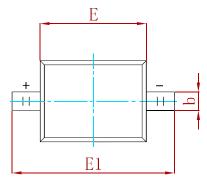
	VRWM	V _{BR}	Ιτ	I⊤ Vc mA) @1A	Vc		IR	С
P/N	(V)	(V)	(mA)		(Max)	(@A)	μΑ (Max)	(Pf) (Typ.)
PSD05C-MS	5	6	1	9.8	17	15	10	25

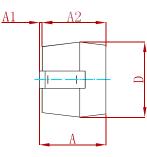
Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

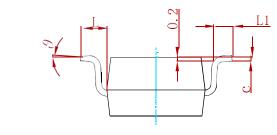
Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20µs)	Ррр	320	W	
ESD per IEC 61000-4-2 (Air)	Vesd	± 15	Kv	
ESD per IEC 61000-4-2 (Contact)	VESD	± 8		
Operating Temperature Range	TJ	-55 to +125	°C	
Storage Temperature Range	Тѕтј	-55 to +150	°C	



PACKAGE MECHANICAL DATA

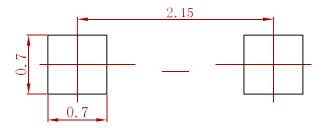






Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A		1.000		0.039	
A 1	0.000	0.100	0.000	0.004	
A2	0.800	0.900	0.031	0.035	
b	0.250	0.350	0.010	0.014	
с	0.080	0.150	0.003	0.006	
D	1.200	1.400	0.047	0.055	
E	1.600	1.800	0.063	0.071	
E1	2.550	2.750	0.100	0.108	
L	0.475	REF.	0.019 REF.		
L1	0.250	0.400	0.010	0.016	
θ 0°		8°	0°	8°	

Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.

3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
PSD05C-MS	SOD-323	3000



PSD05C-MS HF Semiconductor Compiance

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